

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT4433447

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
QUANBO ZOU	05/16/2017
ZHE WANG	05/18/2017
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	GOERTEK, INC.
<b>Street Address:</b>	268 DONGFANG ROAD
<b>Internal Address:</b>	HI-TECH INDUSTRY DISTRICT
<b>City:</b>	WEIFANG CITY, SHANDONG
<b>State/Country:</b>	CHINA
<b>Postal Code:</b>	261031
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	15531243
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<b>ATTORNEY DOCKET NUMBER:</b>	4626-106
<b>NAME OF SUBMITTER:</b>	STEVEN J. HULTQUIST
<b>SIGNATURE:</b>	/steven j. hultquist/
<b>DATE SIGNED:</b>	05/26/2017
<b>Total Attachments: 1</b> source=106_Assignment#page1.tif	

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**ASSIGNMENT**

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We, **QUANBO ZOU**, and **ZHE WANG**, have made an invention the specification of which is described in the U.S. patent application filed herewith in the United States Patent and Trademark Office entitled:

**"ASSEMBLING METHOD, MANUFACTURING METHOD, DEVICE AND ELECTRONIC APPARATUS OF FLIP-DIE"**

We hereby assign to **Goertek, Inc., 268 Dongfang Road, Hi-Tech Industry District, Weifang City, Shandong 261031, CHINA**, all ownership and rights in:

- (i) the invention and U.S. Patent Application;
- (ii) non-provisional, continuing, divisional and continuation-in-part applications based on and claiming benefit and/or priority of said U.S. Patent Application;
- (iii) U.S. Patents on the invention; and
- (iv) corresponding foreign patent applications and patents.

We are making this assignment based on our business relationship with **Goertek, Inc.**

We respectfully request the Commissioner for Patents of the United States and the appropriate officers of all foreign countries to issue patents on the invention to:

**Goertek, Inc.**

as owner of the invention and aforementioned patent rights.

We agree to execute any other legal documents that may be required to effectuate this Assignment.

We agree that we will promptly communicate to **Goertek, Inc.** all facts which come to our attention affecting the invention or patent rights.

We agree that we will testify in any interference or litigation involving the invention or patent rights.

We declare that we have not done anything in conflict with this Assignment.

*Quanbo Zou*

05/16/2017

Quanbo Zou

Date (mm/dd/yyyy)

*Zhe Wang*

05/18/2017

Zhe Wang

Date (mm/dd/yyyy)